

L Number	Hits	Search Text	DB	Time stamp
1	369	((heat\$3 adj (section or zone or chamber)) and (react\$3 adj (section or zone or chamber)) and puls\$3 and (nozzle or inject\$3 or inlet)) not (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon) and heat\$3) not ( (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/08 10:15
2	58	((heat\$3 adj (section or zone or chamber)) and (react\$3 adj (section or zone or chamber)) and puls\$3 and (nozzle or inject\$3 or inlet)) not (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon) and heat\$3) not ( (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 )))) not ((heat\$3 adj (section or zone or chamber)) and (react\$3 adj (section or zone or chamber)) and puls\$3 and (gas same (nozzle or inject\$3 or inlet)) ) not (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon) and heat\$3) not ( (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/08 10:16
3	4	((heat\$3 adj (section or zone or chamber)) and (react\$3 adj (section or zone or chamber)) and puls\$3 and ((nozzle or inject\$3 or inlet)) ) and (silicon near granule)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/08 10:25

-	2838	((422/129,139,145,146,147) or (118/716)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 09:46
-	1409	((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/06 17:38
-	94	((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3 and puls\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 10:59
-	2	("20020081250").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/06 18:18
-	3254	(422/198,194,190,110).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 09:00
-	92	((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 09:01
-	87	((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3 not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 09:01
-	2838	((422/129,139,145,146,147) or (118/716)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 09:46
-	8	((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 13:39
-	439	((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon)) not (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 11:01
-	94	((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3 and puls\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 10:59

-	324	(((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon) and heat\$3) not ( (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 12:39
-	319	(heat\$3 adj (section or zone or chamber)) and (react\$3 adj (section or zone or chamber)) and puls\$3 and (gas same (nozzle or inject\$3 or inlet))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/07 12:47
-	311	((heat\$3 adj (section or zone or chamber)) and (react\$3 adj (section or zone or chamber)) and puls\$3 and (gas same (nozzle or inject\$3 or inlet)) ) not (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ) ((((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon) and heat\$3) not ( (((422/198,194,190,110).CCLS.) and heat\$3 and puls\$3) not (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ) (((422/198,194,190,110).CCLS.) or (((422/129,139,145,146,147) or (118/716)).CCLS.)) and (silicon near granule)) (((422/129,139,145,146,147) or (118/716)).CCLS.) and heat\$3) and puls\$3 ))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/08 10:15
-	4	((heat\$3 adj (section or zone or chamber)) and (react\$3 adj (section or zone or chamber)) and puls\$3 and (gas same (nozzle or inject\$3 or inlet)) ) and (silicon near granule)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/08 10:24